

Three-PLL Programmable Clock Generator with Spread Spectrum

Features

- Three fully integrated phase-locked loops (PLLs)
- Input frequency range
 - □ External crystal: 8 to 48 MHz
 - □ External reference: 8 to 166 MHz clock
- Reference clock input voltage range
 □ 2.5 V, 3.0 V, and 3.3 V for CY25483
 □ 1.8 V for CY25403 and CY25423
- Wide operating output frequency range
 □ 3 to 166 MHz
- Programmable spread spectrum with center and down spread option and lexmark and linear modulation profiles
- V_{DD} supply voltage options
 □ 2.5 V, 3.0 V, and 3.3 V for CY25403 and CY25483
 □ 1.8 V for CY25423
- Frequency select feature with option to select four different frequencies
- Power-down, output enable, and SS ON/OFF controls
- Low jitter, high accuracy outputs
- Ability to synthesize nonstandard frequencies with Fractional-N capability
- Three clock outputs with programmable drive strength
- Glitch-free outputs while frequency switching

- 8-pin SOIC package
- Commercial and Industrial temperature ranges
- One-time programmability
 For programming support, contact Cypress technical support or send an e-mail to clocks@cypress.com

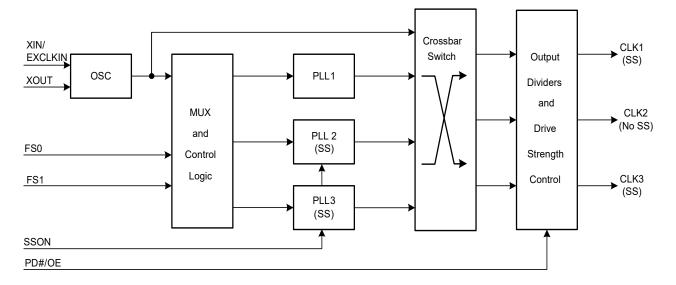
Benefits

- Multiple high-performance PLLs allow synthesis of unrelated frequencies
- Nonvolatile programming for personalization of PLL frequencies, spread spectrum characteristics, drive strength, crystal load capacitance, and output frequencies
- Application specific programmable EMI reduction using Spread Spectrum for clocks
- Programmable PLLs for system frequency margin tests
- Meets critical timing requirements in complex system designs
- Suitability for PC, consumer, portable, and networking applications
- Capable of Zero PPM frequency synthesis error
- Uninterrupted system operation during clock frequency switch
- Application compatibility in standard and low-power systems

Functional Description

For a complete list of related documentation, click here.

Block Diagram



Revised October 31, 2017



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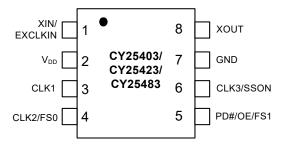


Device Selector Guide

Device	Crystal Input	EXCLKIN Input	V _{DD}
CY25403	Yes	1.8 V LVCMOS	2.5 V, 3.0 V, 3.3 V
CY25483	No	2.5 V, 3.0 V, 3.3 V LVCMOS	2.5 V, 3.0 V, 3.3 V
CY25423	Yes	1.8 V LVCMOS	1.8 V

Pin Configuration

Figure 1. 8-pin SOIC pinout CY25403/CY25423/CY25483



Pin Definitions

CY25403/CY25423/CY25483

Pin Number	Name	Ю	Description
1	XIN/EXCLKIN	Input	Crystal input or external clock input (Refer Device Selector Guide on page 3)
2	V_{DD}	Power	Power supply (Refer Device Selector Guide on page 3)
3	CLK1	Output	Programmable clock output with spread spectrum
4	CLK2/FS0	Output/Input	Multifunction programmable pin: programmable clock output with no spread spectrum or frequency select pin
5	PD#/OE/FS1	Input	Multifunction programmable pin: power-down, output enable, or frequency select pin
6	CLK3/SSON	Output/Input	Multifunction programmable pin: programmable clock output with spread spectrum or spread spectrum ON/OFF control pin
7	GND	Power	Power supply ground
8	XOUT	Output	Crystal output



Functional Overview

Configurable PLLs

The CY25403/CY25423/CY25483 have three programmable PLLs that can be used to generate output frequencies ranging from 3 to 166 MHz. The advantage of having three PLLs is that a single device generates up to three independent frequencies from a single crystal.

Input Reference Clocks

The input reference clock can be either a crystal or a clock signal, for CY25403 and CY25423 while just a clock signal for CY25483. The input frequency range for crystal (XIN) is 8 MHz to 48 MHz and that for external reference clock (EXCLKIN) is 8 MHz to 166 MHz. The voltage range of the reference clock input for CY25483 is 2.5 V/3.0 V/3.3 V while that for CY25403 and CY25423 is 1.8 V. This gives user an option for this device to be compatible for different input clock voltage levels in the system.

V_{DD} Power Supply Options

These devices have programmable power supply options. The CY25403/CY25483 is a high voltage part that can be programmed to operate at any voltage 2.5 V, 3.0 V, or 3.3 V while CY25423 is a low voltage part that can operate at 1.8 V.

These devices have programmable input sources for each of its clock outputs. There are four available clock sources and these clock sources are: XIN/EXCLKIN, PLL1, PLL2, and PLL3. Output clock source selection is done by using four out of four crossbar switch. Thus, any one of these four available clock sources can be arbitrarily selected for the clock outputs. This gives user a flexibility to have up to three independent clock outputs.

Spread Spectrum Control

Two of the three PLLs (PLL2 and PLL3) have spread spectrum capability for EMI reduction in the system. The device uses a Cypress proprietary PLL and spread spectrum clock (SSC) technology to synthesize and modulate the frequency of the PLL. The spread spectrum feature can be turned on or off using a multifunction control pin (CLK3/SSON). It can be programmed to either center spread range from ±0.125% to ±2.50% or down spread range from -0.25% to -5.0% with Lexmark or Linear profile.

Frequency Select

Each PLL can be programmed for up to four different frequencies. There are two multifunction programmable pins, CLK2/FS0 and PD#/OE/FS1 which if programmed as frequency select inputs, can be used to select among these arbitrarily programmed frequency settings. Each output has programmable output divider options.

Glitch-Free Frequency Switch

When the frequency select pin, FS(1:0) is used to switch frequency, the outputs are glitch-free provided frequency is switched using output dividers. This feature enables uninterrupted system operation while clock frequency is being switched.

PD#/OE Mode

Multifunction pin PD#/OE/FS1 (Pin 5) can be programmed to operate as either frequency select (FS1), power-down (PD#) or output enable (OE) mode. PD# is a low-true input. If activated it shuts off the entire chip, resulting in minimum power consumption for the device. Setting this signal high brings the device in the operational mode with default register settings.

When this pin is programmed as output enable (OE), clock outputs can be enabled or disabled using OE (pin 5). Individual clock outputs can be programmed to be sensitive to this OE pin.

Output Drive Strength

The DC drive strength of the individual clock output can be programmed for different values. Table 1 shows the typical rise and fall times for different drive strength settings.

Table 1. Output Drive Strength

Output Drive Strength	Rise/Fall Time (ns) (Typical Value)
Low	6.8
Mid Low	3.4
Mid High	2.0
High	1.0

Generic Configuration and Custom Frequency

There is a generic set of output frequencies available from the factory that can be used for the device evaluation purposes. The device, CY25403/CY25423/CY25483 can be custom programmed to any desired frequencies and listed features. For customer specific programming, contact your local Cypress Field Application Engineer (FAE) or sales representative.



Absolute Maximum Conditions

Parameter	Description	Condition	Min	Max	Unit
V_{DD}	Supply voltage for CY25403/CY25483	-	-0.5	4.5	V
	Supply voltage for CY25423	-	-0.5	2.6	
V _{IN}	Input voltage for CY25403/CY25423/CY25483	Relative to V _{SS}	-0.5	V _{DD} + 0.5	V
T _S	Temperature, Storage	Non Functional	– 65	+150	°C
ESD _{HBM}	ESD protection (human body model)	JEDEC EIA/JESD22-A114-E	2000		Volts
UL-94	Flammability rating	V-0 at 1/8 in.	_	10	ppm
MSL	Moisture sensitivity level	SOIC package	_	3	_

Recommended Operating Conditions

Parameter	Description	Min	Тур	Max	Unit
V_{DD}	V _{DD} operating voltage for CY25403/CY25483	2.25	_	3.60	V
	V _{DD} operating voltage for CY25423	1.65	1.8	1.95	
T _{AC}	Commercial ambient temperature	0	_	+70	°C
T _{AI}	Industrial ambient temperature	-40		+85	°C
C _{LOAD}	Maximum load capacitance	_	_	15	pF
t _{PU}	Power-up time for all $V_{\mbox{\scriptsize DD}}$ to reach minimum specified voltage (power ramps must be monotonic)	0.05	_	500	ms

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DC Electrical Specifications

Parameter	Description	Conditions	Min	Тур	Max	Unit
V_{OL}	Output low voltage	I _{OL} = 2 mA, drive strength = [00]	_	_	0.4	V
		I _{OL} = 3 mA, drive strength = [01]				
		I _{OL} = 7 mA, drive strength = [10]				
		I _{OL} = 12 mA, drive strength = [11]				
V _{OH}	Output high voltage	I _{OH} = -2 mA, drive strength = [00]	$V_{DD} - 0.4$	_	_	V
		$I_{OH} = -3 \text{ mA}$, drive strength = [01]				
		I _{OH} = -7 mA, drive strength = [10]				
		$I_{OH} = -12 \text{ mA}$, drive strength = [11]				
V _{IL1}	Input low voltage of PD#/OE, FS0, FS1 and SSON		_	-	0.2 × V _{DD}	V
V _{IL2}	Input low voltage of EXCLKIN for CY25403/CY25423		-	-	0.3	V
V _{IL3}	Input low voltage of EXCLKIN for CY25483		-	_	0.2 × V _{DD}	V
V _{IH1}	Input high voltage of PD#/OE, FS0, FS1 and SSON		0.8 × V _{DD}	_	_	V
V _{IH2}	Input high voltage of EXCLKIN for CY25403/CY25483		1.62	_	2.2	V
V _{IH3}	Input high voltage of EXCLKIN for CY25423		0.8 × V _{DD}	_	-	V
I _{IL}	Input low current, PD#/OE/FS1	V _{IN} = 0 V	_	_	10	μA
I _{IH}	Input high current, PD#/OE/FS1	$V_{IN} = V_{DD}$	_	_	10	μΑ
I _{ILDN}	Input low current, SSON and FS0 pins	V _{IN} = 0 V (Internal pull-down resistor = 160k typ.)	-	-	10	μΑ
I _{IHDN}	Input high current, SSON and FS0 pins	V _{IN} = V _{DD} (Internal pull-down resistor = 160k typ.)	14	-	36	μΑ
R _{DN}	Pull-down resistor of CLK1, CLK2/FS0 and CLK3/SSON pins	Output clocks in off state by setting PD# = Low	100	160	250	kΩ
I _{DD} ^[1, 2]	Supply current for CY25403/CY25423/CY25483	PD# = High, No load	-	22	_	mA
I _{DDS} ^[1]	Standby current	PD# = Low	-	3	_	μΑ
C _{IN} ^[1]	Input capacitance	SSON, PD#/OE/FS1 and FS0 pins	_	-	7	pF

Thermal Resistance

Parameter [3]	Description	Test Conditions	8-pin SOIC	Unit
θ_{JA}	(junction to ambient)	Test conditions follow standard test methods and procedures for measuring thermal impedance, in	131	°C/W
θ_{JC}	Thermal resistance (junction to case)	accordance with EIA/JESD51.	40	°C/W

Notes

- Guaranteed by design but not 100% tested.
 Configuration dependent.
 These parameters are guaranteed by design and are not tested.



AC Electrical Specifications

Parameter	Description	Conditions	Min	Тур	Max	Unit
F _{IN} (crystal)	Crystal frequency, XIN	_	8	_	48	MHz
F _{IN} (clock)	Input clock frequency (EXCLKIN)	_	8	_	166	MHz
F _{CLK}	Output clock frequency	_	3	-	166	MHz
DC	Output duty cycle, all clocks except ref out	Output duty cycle, all clocks		50	55	%
DC	Ref out duty cycle	Ref In Min 45%, Max 55%	40	_	60	%
T _{RF1} ^[4]	Output rise/fall time	Measured from 20% to 80% of V _{DD} , as shown in Figure 4 on page 9, CL = 15 pF, drive strength [00]	_	6.8	_	ns
T _{RF2} ^[4]	Output rise/fall time	Measured from 20% to 80% of V _{DD} , as shown in Figure 4 on page 9, CL = 15 pF, drive strength [01]	_	3.4	_	ns
T _{RF3} ^[4]	Output rise/fall time	Measured from 20% to 80% of V _{DD} , as shown in Figure 4 on page 9, CL = 15 pF, drive strength [10]	_	2.0	_	ns
T _{RF4} ^[4]	Output rise/fall time	Measured from 20% to 80% of V _{DD} , as shown in Figure 4 on page 9, CL = 15 pF, drive strength [11]	_	1.0	_	ns
T _{CCJ} ^[4, 5]	Cycle-to-cycle jitter (peak)	Configuration dependent. See Configuration Example on page 8	_	100	-	ps
T _{LOCK} ^[4]	PLL lock time	Measured from 90% of the applied power supply level	_	1	3	ms

^{4.} Guaranteed by design but not 100% tested.5. Configuration dependent.



Configuration Example

For C-C Jitter

Ref. Frequency	CLK1 Output		CLK2 Output		CLK3 Output		
(MHz)	Freq. (MHz)	C-C Jitter Typ (ps)	Freq. (MHz)	C-C Jitter Typ (ps)	Freq. (MHz)	C-C Jitter Typ (ps)	
14.3181	8.0	134	166	103	48	92	
19.2	74.25	99	166	94	8	91	
27	48	67	27	109	166	103	
48	48	93	27	123	166	137	

Recommended Crystal Specification

For SMD Package

Parameter	Description	Range 1	Range 2	Range 3	Unit
Fmin	Minimum frequency	8	14	28	MHz
Fmax	Maximum frequency		28	48	MHz
R1	Motional resistance (ESR)	135	50	30	Ω
C0	Shunt capacitance	4	4	2	pF
CL	Parallel load capacitance	18	14	12	pF
DL(max)	Maximum crystal drive level	300	300	300	μW

Recommended Crystal Specification

For Thru-Hole Package

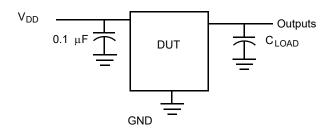
Parameter	Description	Range 1	Range 2	Range 3	Unit
Fmin	Minimum frequency	8	14	24	MHz
Fmax	Maximum frequency	14	24	32	MHz
R1	Motional resistance (ESR)	90	50	30	Ω
C0	Shunt capacitance	7	7	7	pF
CL	Parallel load capacitance	18	12	12	pF
DL(max)	Maximum crystal drive level	1000	1000	1000	μW

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Test and Measurement Setup

Figure 2. Test and Measurement Setup



Voltage and Timing Definitions

Figure 3. Duty Cycle Definition

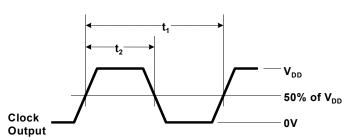
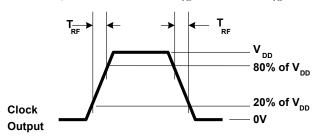


Figure 4. Rise Time = T_{RF} , Fall Time = T_{RF}





Ordering Information

Part Number	Туре	Package	Supply Voltage	Production Flow	
Pb-free					
CY25403SXC	Field Programmable	8-pin SOIC	2.5 V, 3.0 V, or 3.3 V	Commercial, 0 °C to 70 °C	
CY25403SXCT	Field Programmable	8-pin SOIC – Tape and Reel	2.5 V, 3.0 V, or 3.3 V	Commercial, 0 °C to 70 °C	
CY25423SXC	Field Programmable	8-pin SOIC	1.8 V	Commercial, 0 °C to 70 °C	
CY25423SXCT	Field Programmable	8-pin SOIC – Tape and Reel	1.8 V	Commercial, 0 °C to 70 °C	
CY25483SXC	Field Programmable	8-pin SOIC	2.5 V, 3.0 V, or 3.3 V	Commercial, 0 °C to 70 °C	
CY25483SXCT	Field Programmable	8-pin SOIC – Tape and Reel	2.5 V, 3.0 V, or 3.3 V	Commercial, 0 °C to 70 °C	
CY25403SXI	Field Programmable	8-pin SOIC	2.5 V, 3.0 V, or 3.3 V	Industrial, –40 °C to +85 °C	
CY25403SXIT	Field Programmable	8-pin SOIC – Tape and Reel	2.5 V, 3.0 V, or 3.3 V	Industrial, –40 °C to +85 °C	
CY25423SXI	Field Programmable	8-pin SOIC	1.8 V	Industrial, –40 °C to +85 °C	
CY25423SXIT	Field Programmable	8-pin SOIC – Tape and Reel	1.8 V	Industrial, –40 °C to +85 °C	
CY25483SXI	Field Programmable	8-pin SOIC	2.5 V, 3.0 V, or 3.3 V	Industrial, –40 °C to +85 °C	
CY25483SXIT	Field Programmable	8-pin SOIC – Tape and Reel	2.5 V, 3.0 V, or 3.3 V	Industrial, –40 °C to +85 °C	
Programmer					
CY3675-CLKMAKER1		Programming Kit			
CY3675-SOIC8A		Socket Adapter Board, for programming CY25402, CY25403, CY25422, CY25423, CY25482, and CY25483			

Some product offerings are factory programmed customer specific devices with customized part numbers. The Possible Configurations table shows the available device types, but not complete part numbers. Contact your local Cypress FAE or sales representative for more information.

Possible Configurations

Part Number ^[6]	Туре	V _{DD} (V)	Production Flow				
Pb-free	Pb-free						
CY25403/CY25423/CY25483SXC- xxx	8-pin SOIC	Supply Voltage: 2.5 V, 3.0 V, or 3.3 V	Commercial, 0 °C to 70 °C				
CY25403/CY25423/CY25483SXC- xxxT	8-pin SOIC – Tape and Reel	Supply Voltage: 2.5 V, 3.0 V, or 3.3 V	Commercial, 0 °C to 70 °C				
CY25403/CY25423/CY25483SXI-x xx	8-pin SOIC	Supply Voltage: 2.5 V, 3.0 V, or 3.3 V	Industrial, –40 °C to +85 °C				
CY25403/CY25423/CY25483SXI-x xxT	8-pin SOIC – Tape and Reel	Supply Voltage: 2.5 V, 3.0 V, or 3.3 V	Industrial, –40 °C to +85 °C				

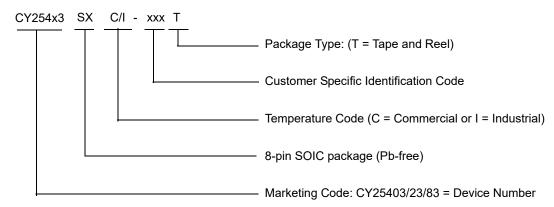
Note

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^{6.} xxx indicates factory programmed parts based on customer specific configuration. For more details, contact your local Cypress FAE or sales representative.



Ordering Code Definitions

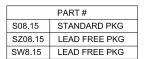


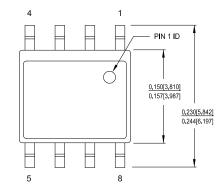


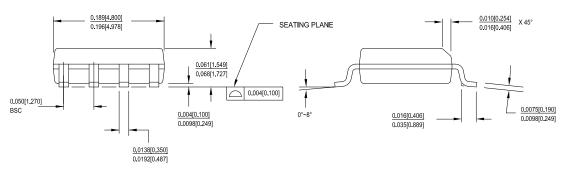
Package Drawing and Dimensions

Figure 5. 8-pin SOIC (150 Mils) S0815/SZ815/SW815 Package Outline, 51-85066

- 1. DIMENSIONS IN INCHES[MM] MIN.
- PIN 1 ID IS OPTIONAL,
 ROUND ON SINGLE LEADFRAME
 RECTANGULAR ON MATRIX LEADFRAME
- 3. REFERENCE JEDEC MS-012
- 4. PACKAGE WEIGHT 0.07gms







51-85066 *I



Acronyms

Acronym	Description		
DL	drive level		
DNU	do not use		
DUT	device under test		
EIA	Electronic Industries Alliance		
EMI	electromagnetic interference		
ESD	electrostatic discharge		
FAE	field application engineer		
FS	frequency select		
JEDEC	Joint Electron Devices Engineering Council		
LVCMOS	low voltage complementary metal oxide semiconductor		
OE	output enable		
osc	oscillator		
PD	power-down		
PLL	phase-locked loop		
PPM	parts per million		
SS	spread spectrum		
SSC	spread spectrum clock		
SSON	spread spectrum on		

Document Conventions

Units of Measure

Symbol	Unit of Measure		
°C	degree Celsius		
MHz	megahertz		
μA	microampere		
mA	milliampere		
ms	millisecond		
ns	nanosecond		
pF	picofarad		
ps	picosecond		
V	volt		



Document History Page

Rev.	ECN No.	Orig. of Change	Submission Date	Description of Change
**	690296	RGL	01/17/2007	New data sheet.
*A	815788	RGL	03/02/2007	Minor Change: To post on web.
*B	1428744	RGL / AESA	08/30/2007	Updated Document Title to read as "CY25403/CY25423/CY25483 Three PLI Programmable Clock Generator with Spread Spectrum". Changed status from Preliminary to Final. Added CY25483 part related information in all instances across the document Updated Block Diagram. Updated Pin Definitions: Updated details in "Description" column. Updated Functional Overview: Updated description and added sub-sections. Updated Absolute Maximum Conditions: Updated details corresponding to V _{DD} and V _{IN} parameters. Updated Recommended Operating Conditions: Updated Recommended Operating Conditions: Updated DC Electrical Specifications: Updated almost entire table. Updated Ordering Information: Updated part numbers.
*C	2748211	TSAI	08/10/2009	Post to external web.
*D	2899300	CXQ	03/25/2010	Updated Ordering Information: Added Possible Configurations. Added Note 6 and referred the same note in "Part Number" column. Updated Package Drawing and Dimensions: spec 51-85066 – Changed revision from *C to *D.
*E	2898568	CXQ	06/02/2010	Updated Ordering Information: Updated part numbers. Added Ordering Code Definitions. Added Acronyms. Updated to new template.
*F	3319132	BASH	07/18/2011	Updated Package Drawing and Dimensions: spec 51-85066 – Changed revision from *D to *E. Added Units of Measure. Updated to new template.



Document History Page (continued)

Rev.	ECN No.	Orig. of Change	Submission Date	Description of Change
*G	4468493	TAVA	08/12/2014	Updated Features: Updated details under "Reference clock input voltage range", "V _{DD} supply voltage options:", and "Selectable output clock voltages independent of V _{DD} supply:". Updated Device Selector Guide: Updated details in "Crystal Input", "EXCLKIN Input" and "V _{DD} " columns. Updated Pin Definitions: Updated Pin Definitions: Updated details in "Description" column corresponding to pin numbers 1 and 2 Updated Functional Overview: Updated Input Reference Clocks: Updated description. Updated VDD Power Supply Options: Updated description. Updated Absolute Maximum Conditions: Updated Recommended Operating Conditions: Updated Recommended Operating Conditions: Updated DC Electrical Specifications: Updated DC Electrical Specifications: Updated details corresponding to V _{IH2} parameter. Added V _{IH3} parameter and its details. Updated Package Drawing and Dimensions: spec 51-85066 - Changed revision from *E to *F. Updated to new template. Completing Sunset Review.
*H	4586478	TAVA	12/03/2014	Updated Functional Description: Added "For a complete list of related documentation, click here." at the end.
*	5279365	PSR	05/20/2016	Added Thermal Resistance. Updated Package Drawing and Dimensions: spec 51-85066 – Changed revision from *F to *H. Updated to new template. Completing Sunset Review.
*J	5778174	PSR	06/19/2017	Updated Features: Added one-time programmability.
*K	5952739	XHT	10/31/2017	Updated DC Electrical Specifications: Updated details in "Description" and "Max" columns corresponding to V _{IL2} parameter. Added V _{IL3} parameter and its details. Updated Package Drawing and Dimensions: spec 51-85066 – Changed revision from *H to *I. Updated to new template.



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